SE30PAB, SE30PAD, SE30PAG, SE30PAJ

Vishay General Semiconductor

RoHS COMPLIANT

HALOGEN

FREE

Surface Mount ESD Capability Rectifiers



DO-221BC (SMPA)

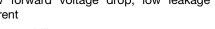
PRIMARY CHARACTERISTICS					
I _{F(AV)}	3.0 A				
V _{RRM}	100 V, 200 V, 400 V, 600 V				
I _{FSM}	32 A				
V_F at $I_F = 3.0$ A $(T_A = 125 ^{\circ}C)$	1.00 V				
I _R	5 μΑ				
T _J max.	175 °C				
Package	DO-221BC (SMPA)				
Diode variations	Single die				

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage



- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

MECHANICAL DATA

Case: DO-221BC (SMPA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE30PAB	SE30PAD	SE30PAG	SE30PAJ	UNIT
Device marking code		30B	30D	30G	30J	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum DC forward current	I _F ⁽¹⁾	3.0				Α
Waxiinum DC Iorward Current	I _F ⁽²⁾	1.4				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	32			Α	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175				°C

Notes

- (1) Mounted on 20 mm x 20 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C		0.98	-	V	
	I _F = 3.0 A		V _E (1)	1.07	1.16		
	I _F = 1.5 A	T _A = 125 °C	V _F (')	0.88	-		
	I _F = 3.0 A			1.00	1.10		
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5	μА	
	nateu v _R	T _A = 125 °C	IR (=/	7	100		
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	1.3	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	13	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)						
PARAMETER SYMBOL SE30PAB SE30PAG SE30PAJ UNIT						UNIT
Typical thormal registance		120			°C/W	
Typical thermal resistance	R _{0JM} (2)	9			C/VV	

Notes

 $^{(1)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

Mounted on 20 mm x 20 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)							
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE							
AEC-Q101-001	01 Human body model (contact mode) $C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$ V_C H3B $> 8 \text{ kV}$						

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE30PAJ-M3/I	0.033	I	14 000	13" diameter plastic tape and reel		
SE30PAJHM3/I (1)	0.033	1	14 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

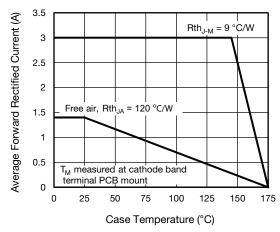


Fig. 1 - Maximum Forward Current Derating Curve

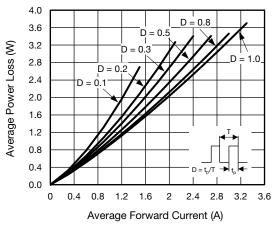


Fig. 2 - Forward Power Loss Characteristics

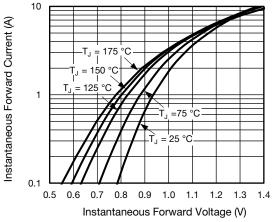


Fig. 3 - Typical Instantaneous Forward Characteristics

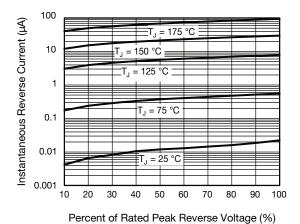


Fig. 4 - Typical Reverse Leakage Characteristics

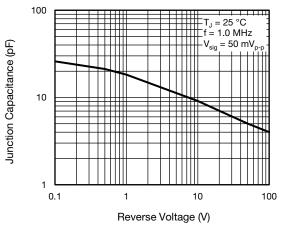


Fig. 5 - Typical Junction Capacitance

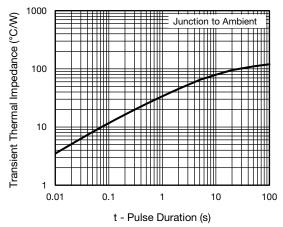


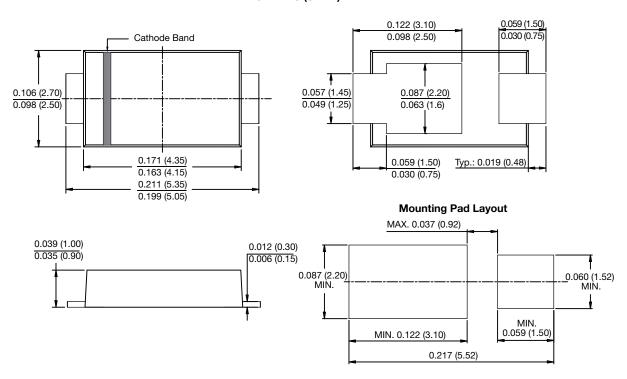
Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221BC (SMPA)





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